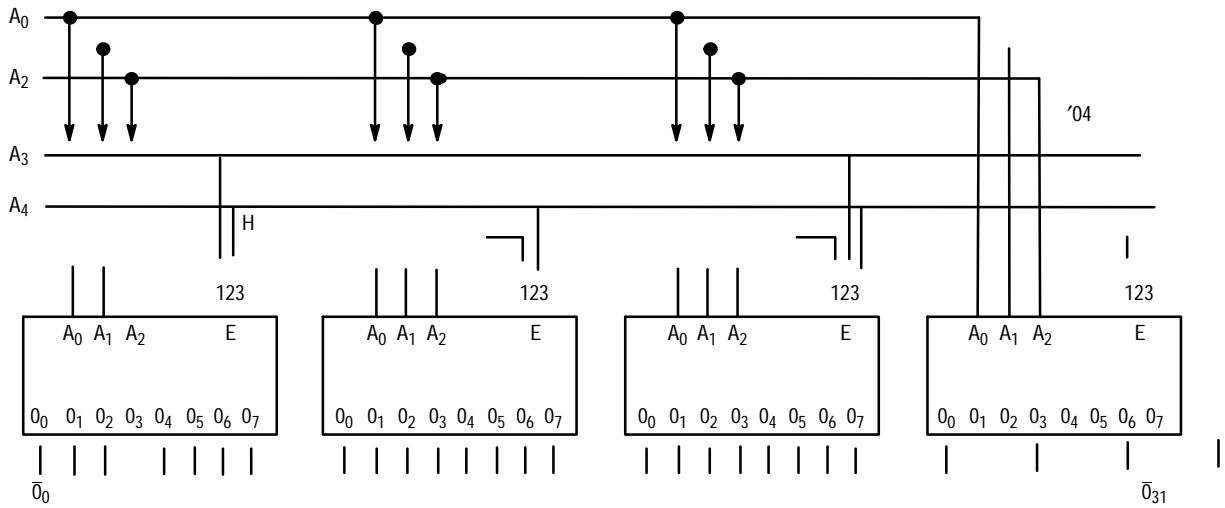




The MC74AC138/74ACT138 high-speed 1-of-8 decoder/demultiplexer accepts three binary weighted inputs (A_0, A_1, A_2) and, when enabled, provides eight mutually exclusive active-LOW outputs ($\overline{O}_0-\overline{O}_7$). The MC74AC138/74ACT138 features three Enable inputs, two active-LOW ($\overline{E}_1, \overline{E}_2$) and one active-HIGH (E_3). All outputs will be HIGH unless \overline{E}_1 and \overline{E}_2 are LOW and E_3 is

HIGH. This multiple enabled function allows easy parallel expansion of the device to a 1-of-32 (5 lines to 32 lines) decoder with just four MC74AC138/74ACT138 devices and one inverter (See Figure 4). The MC74AC138/74ACT138 can be used as an 8-output demultiplexer by using one of the active LOW Enable inputs as the data input and the other Enable inputs as strobes. The Enable inputs which are not used must be permanently tied to their appropriate active-HIGH or active-LOW state.





V _{CC}	DC Supply Voltage		-0.5 to +6.5	V
V _I	DC Input Voltage		$-0.5 \leq V_I \leq V_{CC} + 0.5$	V
V _O	DC Output Voltage	(Note 1)	$-0.5 \leq V_O \leq V_{CC} + 0.5$	V
I _{IK}	DC Input Diode Current		±20	mA
I _{OK}	DC Output Diode Current		±50	mA
I _O	DC Output Sink/Source Current		±50	mA
I _{CC}	DC Supply Current per Output Pin		±50	mA
I _{GND}	DC Ground Current per Output Pin		±50	mA
T _{STG}	Storage Temperature Range		-65 to +150	C
T _L	Lead temperature, 1 mm from Case for 10 Seconds		260	C
T _J	Junction temperature under Bias		+150	C
θ _{JA}	Thermal Resistance (Note 2)	SOIC TSSOP	126 159	C/W
P _D	Power Dissipation in Still Air at 25 C (Note 3)	SOIC TSSOP	995 787	mW
MSL	Moisture Sensitivity		Level 1	
F _R	Flammability Rating	Oxygen Index: 30% – 35%	UL 94 V-0 @ 0.125 in	
V _{ESD}	ESD Withstand Voltage	Human Body Model (Note 4) Charged Device Model (Note 5)	> 2000 > 1000	V
I _{Latch-Up}	Latch-Up Performance	Above V _{CC} and Below GND at 85 C (Note 6)	±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

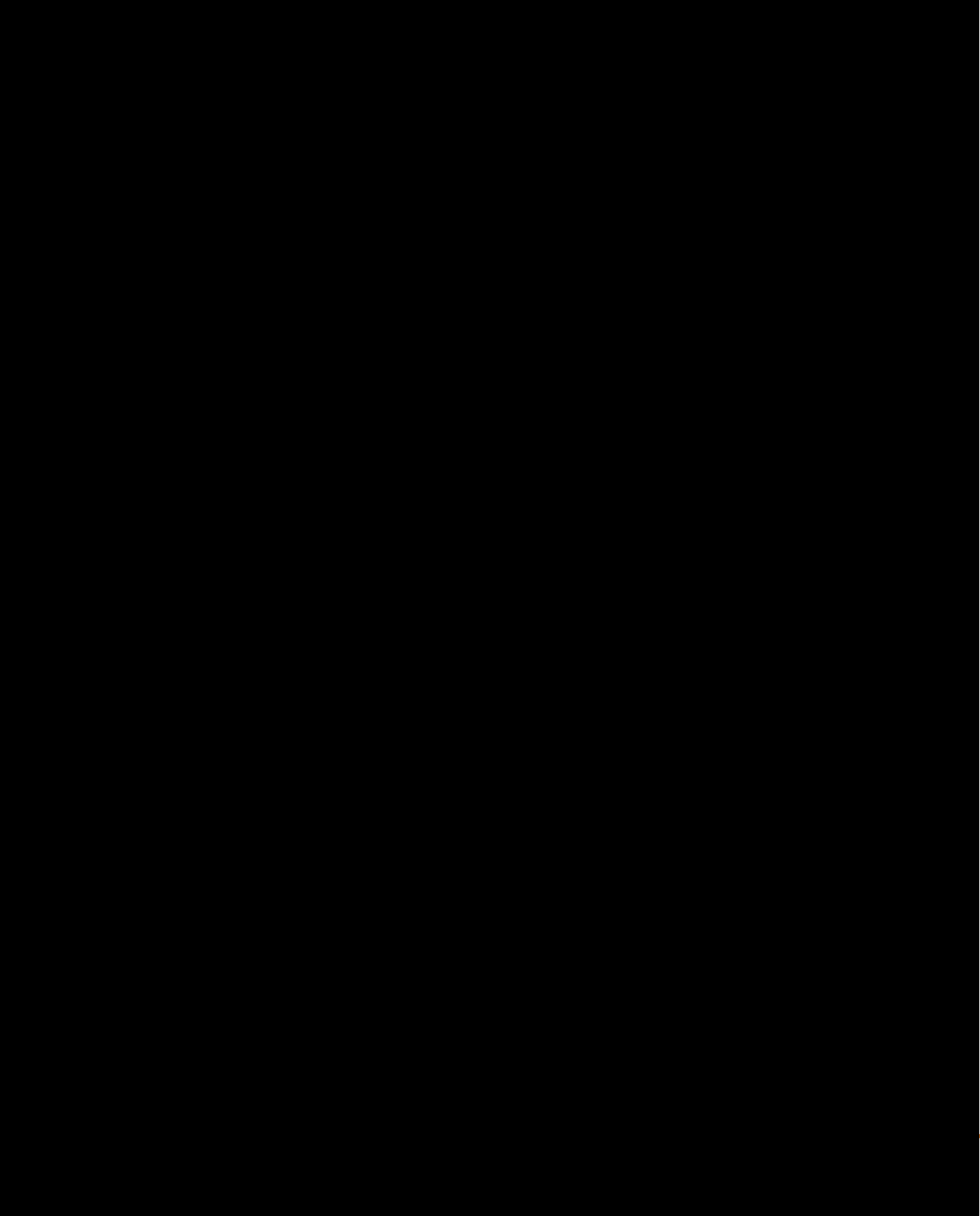
1. I_O absolute maximum rating must be observed.
2. The package thermal impedance is calculated in accordance with JESD51-7.
3. 500 mW at 65 C; derate to 300 mW by 10 mW/ from 65 C to 85 C.
4. Tested to EIA/JESD22-A114-A.
5. Tested to JESD22-C101-A.
6. Tested to EIA/JESD78.

V _{CC}	Supply Voltage	'AC	2.0	5.0	6.0	V
		'ACT	4.5	5.0	5.5	
V _{IN} , V _{OUT}	DC Input Voltage, Output Voltage (Ref. to GND)		0	-	V _{CC}	V
t _r , t _f	Input Rise and Fall Time (Note 1) 'AC Devices except Schmitt Inputs	V _{CC} @ 3.0 V	-	150	-	ns/V
		V _{CC} @ 4.5 V	-	40	-	
		V _{CC} @ 5.5 V	-	25	-	
t _r , t _f	Input Rise and Fall Time (Note 2) 'ACT Devices except Schmitt Inputs	V _{CC} @ 4.5 V	-	10	-	ns/V
		V _{CC} @ 5.5 V	-	8.0	-	
T _A	Operating Ambient Temperature Range		-40	25	85	C
I _{OH}	Output Current – High		-	-	-24	mA
I _{OL}	Output Current – Low		-	-	24	mA

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

1. V_{IN} from 30% to 70% V_{CC}; see individual Data Sheets for devices that differ from the typical input rise and fall times.
2. V_{IN} from 0.8 V to 2.0 V; see individual Data Sheets for devices that differ from the typical input rise and fall times.

					-		
V_{IH}	Minimum High Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	2.1 3.15 3.85	2.1 3.15 3.85	V	$V_{OUT} = 0.1\text{ V}$ or $V_{CC} - 0.1\text{ V}$
V_{IL}	Maximum Low Level Input Voltage	3.0 4.5	1.5 2.25	0.9 1.35	0.9 1.35		$V_{OUT} = 0.1\text{ V}$



					-		
V_{IH}	Minimum High Level Input Voltage	4.5 5.5	1.5 1.5	2.0 2.0	2.0 2.0	V	$V_{OUT} = 0.1\text{ V}$ or $V_{CC} - 0.1\text{ V}$
V_{IL}	Maximum Low Level Input Voltage	4.5 5.5	1.5 1.5	0.8 0.8	0.8 0.8	V	$V_{OUT} = 0.1\text{ V}$ or $V_{CC} - 0.1\text{ V}$
V_{OH}	Minimum High Level Output Voltage	4.5 5.5	4.49 5.49	4.4 5.4	4.4 5.4	V	$I_{OUT} = -50\ \mu\text{A}$

			†
MC74AC138DG	AC138	SOIC-16 (Pb-Free)	48 Units / Rail
MC74AC138DR2G	AC138	SOIC-16 (Pb-Free)	2500 Tape & Reel
MC74AC138DTR2G	AC 138	TSSOP-16 (Pb-Free)	2500 Tape & Reel
MC74ACT138DG	ACT138	SOIC-16 (Pb-Free)	48 Units / Rail
MC74ACT138DR2G	ACT138	SOIC-16 (Pb-Free)	2500 Tape & Reel
MC74ACT138DR2G-Q*	ACT138	SOIC-16 (Pb-Free)	2500 Tape & Reel
MC74ACT138DTR2G	ACT 138	TSSOP-16 (Pb-Free)	2500 Tape & Reel

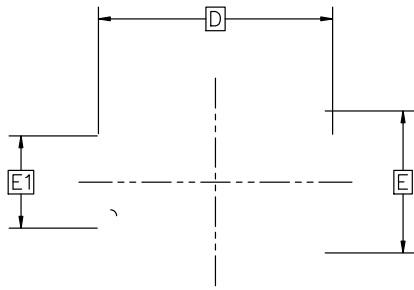


SOIC-16 9.90x3.90x1.37 1.27P
CASE 751B
ISSUE M

DATE 18 OCT 2024

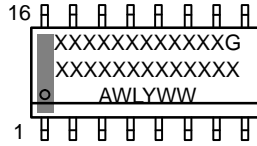
- 3. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD PROTRUSION.
- 4. MAXIMUM MOLD PROTRUSION 0.17

b DIMENSION AT MAXIMUM MATE nm TOTAL IN EXCESS OF THE



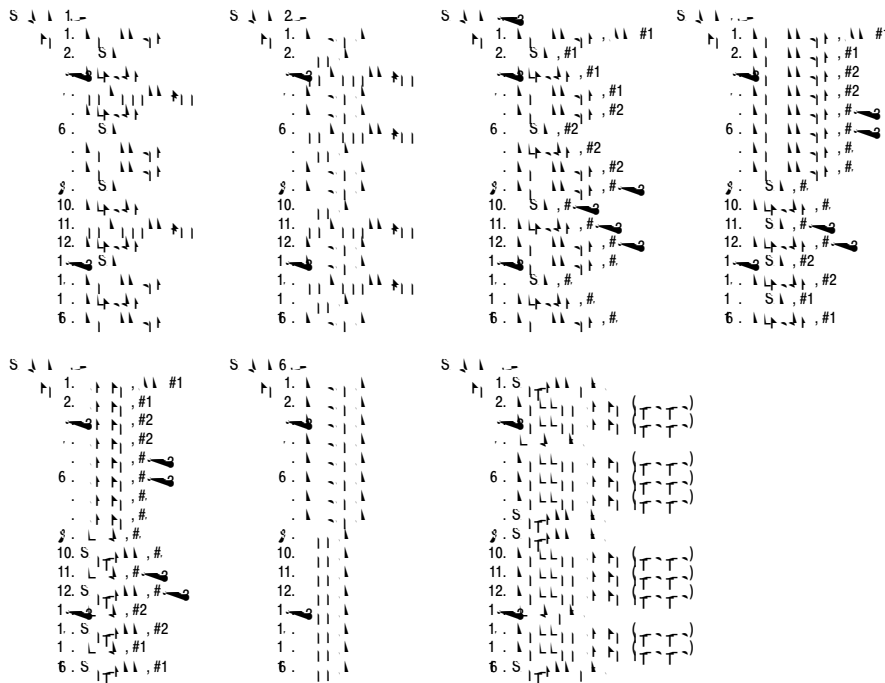
TOP VIEW

**GENERIC
MARKING DIAGRAM***



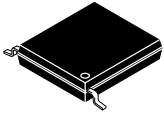
XXXXX = Specific Device Code
A = Assembly Location
WL = Wafer Lot
Y = Year
WW = Work Week
G = Pb Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



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DESCRIPTION:	SOIC-16 9.90X3.90X1.37 1.27P	PAGE 2 OF 2

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SCALE 2:1

TSSOP-16 WB
CASE 948F
ISSUE B

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